

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4672297

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NEXPACK LIMITED	10/10/2017
RECEIVING PARTY DATA	
Name:	MODUWARE PTY LTD
Street Address:	502/37 SWANSTON STREET
City:	MELBOURNE, VICTORIA 3000
State/Country:	AUSTRALIA
PROPERTY NUMBERS Total: 4	
Property Type	Number
Application Number:	15315729
Application Number:	15315730
Application Number:	15445965
Patent Number:	9591113
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	EAGLE IP LIMITED
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ATTORNEY DOCKET NUMBER:	N022.2.NPOCONUS.7-8NPOUS
NAME OF SUBMITTER:	JACQUELINE C. LUI
SIGNATURE:	/Jacqueline C. Lui/
DATE SIGNED:	11/03/2017
Total Attachments: 2	
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source=00200595_Assignment_US_signed#page2.tif	

ASSIGNMENT

WHEREAS, we,

NexPack Limited, a corporation located at Unit 312B, 3/F, IC Development Center, No. 6 Science Park West Avenue, Hong Kong Science Park, Shaan, N.T., Hong Kong (hereinafter "Assignor"), made certain new and useful inventions and improvements (hereinafter "Inventions and Improvements") that have been documented in specifications, for which we have executed below applications for patent in the United States (hereinafter "Applications")

Filing date	Application no.	Title
2 February 2016	14909740	Adaptor Enabling an Electronic Communication Device with Additional Functions
2 December 2016	15315729	Super Hub System and The Method Thereof
2 December 2016	15315730	Battery-Powered Platform for Interchangeable Modules
28 February 2017	15445965	Adaptor Enabling an Electronic Communication Device with Additional Functions

AND WHEREAS, Moduware PTY LTD, organized and existing under and by virtue of the laws of Australia, and having an office and place of business at 502/37 Swanston Street, Melbourne, Victoria 3000, Australia (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said Inventions and Improvements and said Applications and in and to the patent to be obtained therefrom.

NOW THEREFORE, to all whom it may concern, be it known that in consideration of One Dollar (USD 1.00), and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold, assigned, and transferred, and by these present do sell, assign and transfer unto said Assignee, its successors, legal representatives or assigns, the entire right, title and interest for all countries in and to all inventions disclosed in said Applications, and in and to the said Applications, all divisions, continuations or renewals thereof, all patents which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any country or countries foreign to the United States for patents on said Inventions and Improvements, including an assignment of all rights under the provisions of the International Convention, and all patents of any country or countries foreign to the United States which may be granted therefrom; and we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue any and all United States Patents, and any official of any country or countries foreign to the United States, whose duty is to issue patents on applications as aforesaid, to issue any and all patents, for the said Inventions and Improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of said Assignee, its successors, legal representatives and assigns.

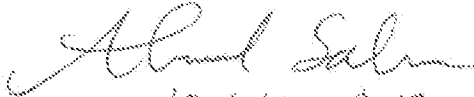
AND, for the consideration aforesaid, we do hereby agree that we and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors, legal representatives and assigns all facts known to us relating to said Inventions and Improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors, legal representatives or assigns the entire right, title and interest in and to the said Inventions and Improvements, Application, patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore we covenant and agree with said Assignee, its successors, legal representatives or assigns, that no assignment, grant, mortgage license or other agreement affecting the rights and property herein conveyed has been made to others by us and that full right to convey the same as herein expressed is possessed by us.

SIGNED this 10th day of Oct, 2017 in Melbourne, Australia
(month) (year) (city) (country)


5022 US

Assignor:


10 / 10 / 2017

NexPack Limited
Address: Unit 312B, 3/F, IC Development Center, No. 6
Science Park West Avenue, Hong Kong Science Park,
Sha Tin, N.T., Hong Kong.
Name Printed: Ahmad SALEM
Title: COO

Assignee:

 10/10/2017

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